PRELIMINARY

May 9, 2008

DS32EL0124 DS32ELX0124 125 MHz — 312.5 MHz Deserializer with DDR LVDS Parallel Interface

General Description

The DS32EL0124/DS32ELX0124 integrates clock and data recovery modules for high-speed serial communication over FR-4 printed circuit board backplanes, balanced cables, and optical fiber. This easy-to-use chipset integrates advanced signal and clock conditioning functions, with an FPGA friendly interface.

The DS32EL0124/DS32ELX0124 deserializes up to 3.125 Gbps of high speed serial data to 5 LVDS outputs without the need for an external reference clock. With DC-balance decoding enabled, the application payload of 2.5 Gbps is deserialized to 4 LVDS outputs.

The DS32EL0124/DS32ELX01214 deserializers feature a remote sense capability to automatically signal link status conditions to its companion DS32EL0421/ELX0421 serializers without requiring an additional feedback path.

The parallel LVDS interface of these devices reduce FPGA I/O pins, board trace count and alleviates EMI issues, when compared to traditional single-ended wide bus interfaces.

The DS32EL0124/ELX0124 is programmable through a SM-Bus interface as well as through control pins.

Applications

- Imaging: Industrial, Medical Security, Printers
- Displays: LED walls, Commercial
- Video Transport
- Communication Systems
- Test and Measurement
- Industrial Bus

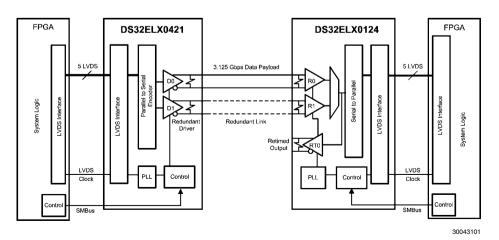
Features

- 5-bit LVDS parallel data interface
- Programmable Receive Equalization
- Selectable DC-balance decoder
- Selectable De-scrambler
- Remote Sense for automatic detection and negotiation of link status
- No external receiver reference clock required
- LVDS parallel interface
- Programmable LVDS output clock delay
- Supports output data-valid signaling
- Supports keep-alive clock output
- On chip LC VCOs
- Redundant serial input (ELX device only)
- Retimed serial output (ELX device only)
- Configurable PLL loop bandwidth
- Configurable via SMBus
- Loss of lock and error reporting
- 48-pin LLP package with exposed DAP

Key Specifications

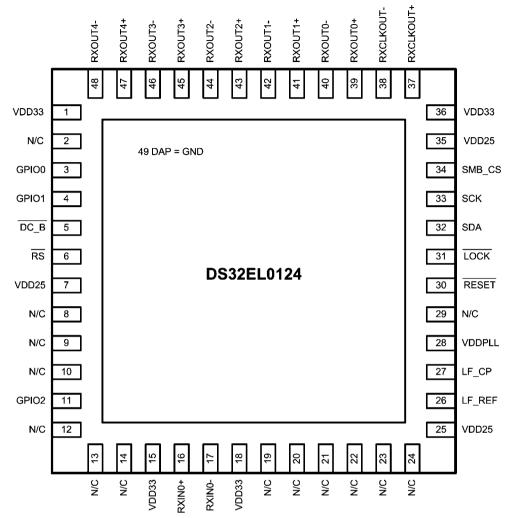
- 1.25 to 3.125 Gbps serial data rate
- 125 to 312.5 MHz DDR parallel clock
- -40° to +85°C temperature range
- > 8 kV ESD (HBM) protection
- High Jitter Tolerance TBD
- Low Jitter Transfer TBD

Typical Application

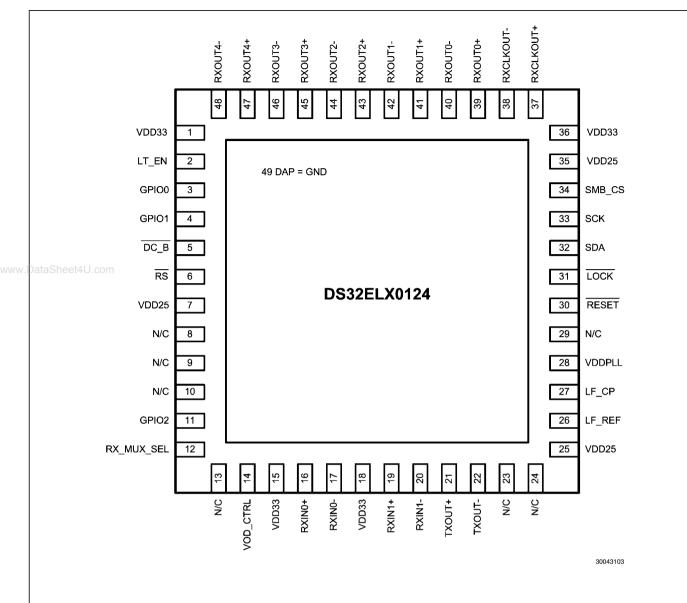


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Pin Diagrams



30043102



Pin	Des	crip	tio	ns
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Pin Name	Pin Number	I/O, Type	Description
VDD33	1, 15, 18, 35	I, VDD	3.3V supply
VDD25	7, 25, 35	I, VDD	2.5V supply
VDD_PLL	28	I, VDD	3.3V supply
LF_CP	27	Analog	Loop filter capacitor connection
LF_REF	26	Analog	Loop filter ground reference
Exposed Pad	49	GND	Exposed Pad must be connected to GND by 9 vias.
CML I/O	1	1	
RxIN0+	16	I, CML	Non-inverting and inverting high speed CML differential inputs of the
RxIN0-	17	,	deserializer. These inputs are internally terminated.
RxIN1+	19	I, CML	DS32ELX0124 only. Non-inverting and inverting high speed CML
RxIN1-	20		differential inputs of the deserializer. These inputs are internally
U.com			terminated.
TxOUT+	21	O, CML	DS32ELX0124 only. Retimed serialized high speed output. Non-inverting
TxOUT-	22		and inverting speed CML differential outputs of the deserializer. These
			outputs are internally terminated.
LVDS Parallel	Data Bus		
RxCLKOUT+	37	O, LVDS	Deserializer output clock. RxCLKOUT+/- are the non-inverting and
RxCLKOUT-	38		inverting LVDS recovered clock output pins.
RxOUT[0:4]+/-	39, 40, 41, 42, 43, 44, 45,	O, LVDS	Deserializer output data. RxOUT[0:4]+/- are the non-inverting and
	46, 47, 48		inverting LVDS deserialized output data pins.
Control Pins	1		
LT_EN	2	I, LVCMOS	DS32ELX0124 only. When held high, retimed serialized high speed output is enabled.
RX_MUX_SEL	12	I, LVCMOS	DS32ELX0124 only. RX_MUX_SEL selects the input of the deserializer.
			0 = RxIN0+/- selected
			1 = RxIN1+/- selected
VOD_CTRL	14	I, LVCMOS	DS32ELX0124 only. VOD control. The deserializer loop through output
			amplitude can be adjusted by connecting this pin to a pull-down resistor.
			The value of the pull-down resistor determines the VOD. Use the following equation to determine the value of the pull-down resistor.
DC_B	5	I, LVCMOS	DC-balance and Remote Sense pins. See Application section for device
RS	6	II, EVOIVIOS	behavior.
RESET	30	I, LVCMOS	Reset pin. When held low, reset the device.
TILOLI		1, 2001100	0 = Device Reset
			1 = Normal operation
LOCK	31	O, LVCMOS	Lock indication output. pin goes low when the deserializer is locked to the
			incoming data stream and begins to output data and clock on RxOUT and
			RxCLKOUT respectively.
			0 = Deserializer locked
			1 = Deserializer not locked
SMBus	1	1	
SCK	I, SMBus	33	SMBus compatible clock.
SDA	I/O, SMBus	32	SMBus compatible data line.
SMB_CS	I, SMBus	34	SMBus chip select. When held high, SMBus management control is enabled.
Other			
GPIO0	3	I/O, LVCMOS	Software configurable IO pins.
GPIO1	4	I/O, LVCMOS	Software configurable IO pins.
GPIO2	11	I/O, LVCMOS	Software configurable IO pins.
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N	C	2 ,8, 9, 10, 12, 13, 14, 19,	Misc.	No Connect, for DS32EL0124
		20, 21, 22, 23, 24, 29		
		8, 9, 10, 13, 23, 24, 29	Misc	No Connect, for DS32ELX0124

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/
Distributors for availability and specifications.

Supply Voltage (V _{DD33})	-0.3V to +4V
Supply Voltage (V _{DD25})	-0.3V to +3.0V
LVCMOS Input Voltage	$-0.3V$ to $(V_{DD33} + 0.3V)$
LVCMOS Output Voltage	$-0.3V$ to $(V_{DD33} + 0.3V)$
CML Input/Output Voltage	-0.3V to 3.6V
LVDS Output Voltage	-0.3V to +3.6V
Junction Temperature	+125°C
Storage Temperature Range	−65°C to +150°C

Lead Temperature Range

Soldering (4 sec.) +260°C

Package Thermal Resistance

+25.0°C/W

ESD Susceptibility

HBM ≥8 kV

Recommended Operating Conditions

	Min	Тур	Max	Units
Supply Voltage (V _{DD33})	3.135	3.3	3.485	V
Supply Voltage (V _{DD25})	2.375	2.5	2.625	V
Supply Noise Amplitude			100	mV_{P-P}
from 10 Hz to 50 MHz				
Ambient Temperature (T _A)	-40	+25	+85	°C

Electrical and Timing Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified. (Notes 2, 3, 4)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
LVCMOS	S ELECTRICAL SPECIFICATIONS					
V_{IH}	High Level Input Voltage		2.0		V_{DD}	V
V _{IL}	Low Level Input Voltage		GND		0.8	V
V _{OH}	High Level Output Voltage	I _{OH} = -2mA	2.7	3.3		V
V _{OL}	Low Level Output Voltage	I _{OL} = 2mA			0.3V	V
V _{CL}	Input Clamp Voltage	I _{CL} = -18 mA		-0.9	-1.5	V
I _{IN}	Input Current	$V_{IN} = 0.4V, 2.5V, \text{ or } V_{DD33}$	-35	1	35	μΑ
I _{os}	Output Short Circuit Current	V _{OUT} = 0V (Note 5)		TBD		V
SMBus E	ELECTRICAL SPECIFICATIONS					
V _{SIL}	Data, Clock Input Low Voltage				0.8	V
V _{SIH}	Data, Clock Input High Voltage		2.1		V _{SDD}	V
I _{SPULLUP}	Current through pull-up resistor or current source		4			mA
V _{SDD}	Nominal Bus Voltage		2.375		3.6	V
I _{SLEAKB}	Input Leakage Per Bus Segment			±200		μA
I _{SLEAKP}	Input Leakage Per Pin			±10		μA
C _{SI}	Capacitance for SDA and SCK				10	pF
R _{STERM}	SMBus Termination Resistor Value	V _{SDD} = 3.3V		1000		Ω
SMBus 7	TIMING SPECIFICATIONS					
f _{SMB}	Bus Operating Frequency		10		100	kHz
t _{BUF}	Bus free time between top and start condition		4.7			μs
t _{HD:STA}	Hold time after (repeated) start condition. After this period, the first clock is generated	At I _{SPULLUP} = MAX	4.0			μs
t _{SU:STA}	Repeated Start Condition Setup Time		4.7			μs
t _{HD:DAT}	Data Hold Time		300			ns
t _{SU:DAT}	Data Setup Time		250			ns
t _{LOW}	Clock Low Time		4.7			μs
t _{HIGH}	Clock High Time		4.0		50	μs

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Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _F	Clock/Data Rise Time	20% to 80%			300	ns
t _R	Clock/Data Rise Time				1000	ns
t _{SU:CS}	SMB_CS Setup Time			30		ns
t _{POR}	Time in which the device must be operational after power on				500	ms
LVDS E	LECTRICAL SPECIFICATIONS					
R _{OUT}	Output Termination Resistor	Between OUT+ and OUT-	85	100	115	Ω
I _{os}	Output Short Circuit Current	$V_{OUT} = 0V$, $R_L = 100\Omega$		TBD		
V _{OD}	Differential Output Voltage	$R_1 = 100\Omega$	230		310	mV
ΔV _{OD}	Changes in V _{OD} between complimentary output states	1.7			35	mV
V _{os}	Offset Voltage	1	1.125	1.25	1.375	V
ΔV _{OS}	Change in V _{OS} between complimentary states	1	11120	1.20	35	mV
	Output Short Circuit Current	V 0V D = 4000			50	mA
l _{os}	<u> </u>	$V_{OUT} = 0V, R_L = 100\Omega$			150	ША
	IMING SPECIFICATIONS	Ι		300	1	Inc
t _{ROTR}	LVDS low-to-high transition time		+		-	ps
t _{ROTF}	LVDS high-to-low transition time			300		ps
t _{ROCP}	LVDS output clock period		45	2T		ns
t _{RODC}	RXCLKOUT Duty Cycle		45	50	55	%
t _{RBIT}	LVDS output bit width			TBD		
t _{ROSC}	RXOUT Setup to RXCLKOUT OUT			200		ps
t _{ROHC}	RXOUT Hold to RXCLKOUT OUT			200		ps
t _{ROJD}	LVDS Output Deterministic Jitter			TBD		
t _{ROJR}	LVDS Output Random Jitter			2.5		ps
t _{ROJT}	Peak-to-Peak LVDS Output Jitter			TBD		
t _{RD}	Deserializer propagation delay – Latency			TBD		
t _{RPLLS}	Deserializer phase lock loop set			TBD		
t _{RLAPL}	Deserializer Link Acquisition After PLL Lock.			TBD		
t _{RLA}	Deserializer Lock Time			TBD		
t _{LVSK}	LVDS Output Skew	LVDS Differential Output Skew between + and - pins		20		ps
CML IN	PUT TIMING SPECIFICATIONS					Į.
EQDJ	Residual deterministic jitter at EQ Output			TBD		
TOL _{JIT}	Serial Input Jitter Tolerance			TBD		
CML IN	PUT ELECTRICAL SPECIFICATIONS		•		•	
V _{ID}	Differential input voltage			TBD		
V _{IN}	Single ended input voltage			TBD		
I _{IN}	Input Current			TBD		
R _{IT}	Input Termination			TBD		
ΔR _{IT}	Mismatch in input terminations			TBD		
	TIMED LOOP THROUGH OUTPUT ELECTRICAL S	DECIFICATIONS. DS32ELX0124	ONLY		!	ļ
V _{LTOD}	Output differential voltage			TBD		
R _{LTOT}	Output termination			TBD		
ΔR_{LTOT}	Mismatch in output termination resistors		+	TBD		
	TIMED LOOP THROUGH OUTPUT TIMING SPECI	FICATIONS DS32ELY0124 ONLY		1.22	I	1
	Additive Output Jitter			TBD	Ι	
t _{JIT}	Output Overshoot		+	TBD	-	
tos	Output Overshoot			טטין		

Symbol	Parameter	Conditions	Min	Тур	Max	Units
L	Retimed output driver differential low to high transition time			TBD		
-"	Retimed output driver differential high to low transition time			TBD		
t _{LTRFMM}	Mismatch in Rise/Fall Time			TBD		
t _{LTDE}	Retimed driver de-emphasis width			TBD		

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions at which the device is functional and the device should not be operated beyond such conditions.

Note 2: The Electrical and Timing Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

Note 3: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground except V_{OD} and ΔV_{OD} .

Note 4: Typical values represent most likely parametric norms for V_{CC} = +3.3V and T_A = +25°C, and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

Note 5: Output short circuit current (I_{OS}) is specified as magnitude only, minus sign indicates direction only.

Note 6: Tested with a combination of the 1100000101 (K28.5+ character) and 0011111010 (K28.5- character) patterns. Input stimulus jitter is subtracted algebraically.

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Timing Diagrams

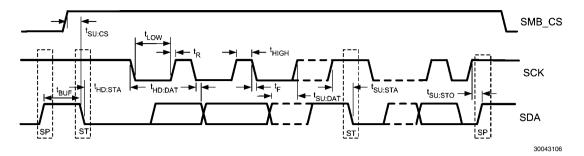


FIGURE 1. SMBus Timing Parameters

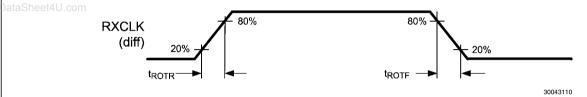


FIGURE 2. LVDS Output Transition Time

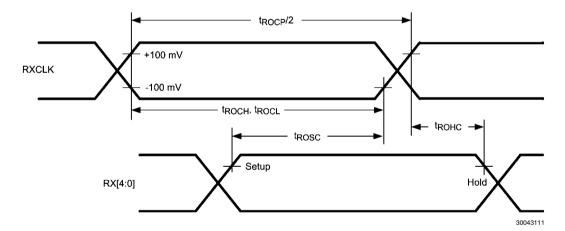


FIGURE 3. Deserializer (LVDS Interface) Setup/Hold and High/Low Times

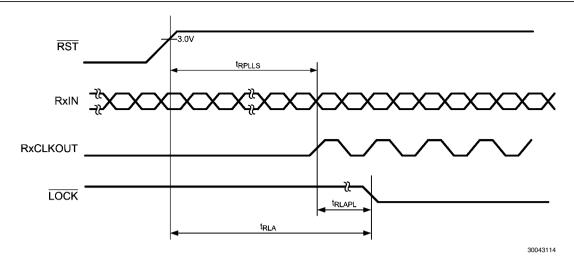


FIGURE 4. Reset to Lock Time

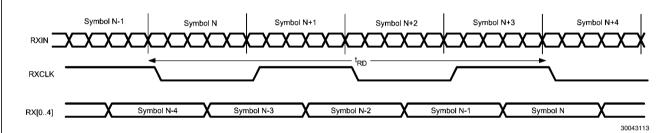
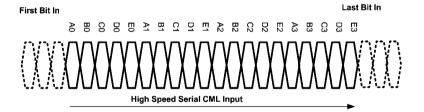


FIGURE 5. Deserializer Propagation Delay



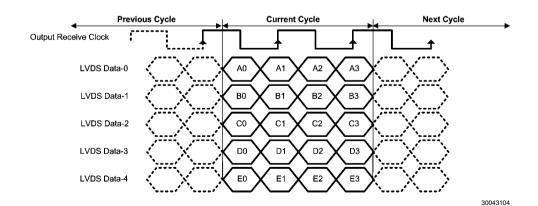


FIGURE 6. CML to LVDS Bit Map

Functional Description

POWER SUPPLIES

The DS32EL0124 and DS32ELX0124 have several power supply pins, at 2.5V as well as 3.3V. It is important that these pins all be connected and properly bypassed. Bypassing should consist of parallel 4.7 μ F and 0.1 μ F capacitors as a minimum, with a 0.1 μ F capacitor on each power pin. A 22 μ F capacitor is required on the VDDPLL pin which is connected to the 3.3V rail.

These devices have a large contact in the center on the bottom of the package. This contact must be connected to the system GND as it is the major ground connection for the device.

POWER UP

It is recommended, although not necessary, to bring up the 3.3V power supply before the 2.5V supply. If the 2.5V supply is powered up first, an initial current draw of approximately 600mA from the 2.5V rail may occur before settling to its final value. Regardless of the sequence, both power rails should monotonically ramp up to their final values.

POWER MANAGEMENT

These devices have two methods to reduce power consumption. To enter the first power save mode, the on board host FPGA or controlling device can cease to output the DDR transmit clock. To further reduce power, a write to the power down register will put the device in its lowest power mode.

RESET

There are three ways to reset these devices. A reset occurs automatically during power-up. The device can also be reset by pulling the RESET pin low, with normal operation resuming when the pin is driven high again. The device can also be reset by writing to the reset register. This reset will put all of the register values back to their default values, except it will not affect the address register value if the SMBus default address has been changed.

LVDS OUTPUTS

The DS32EL0124 and DS32ELX0124 has standard LVDS outputs, compatible with ANSI/TIA/EIA-644. It is recommended that the PCB trace between the FPGA and the deserializer output be no more than 40-inches. Longer PCB traces may introduce signal degradation as well as channel skew which could cause serialization errors. The connection between the host and the DS32EL0124 or DS32ELX0124 should be over a controlled impedance transmission line with impedance that

matches the termination resistor – usually 100Ω . Setup and hold times are specified in the LVDS Switching Characteristics table, however the clock delay can be adjusted by writing to register 30'h.

LOOP FILTER

The DS32EL0124 and DSELX0124 have an internal clock data recovery module (CDR), which is used to recover the input serial data. The loop filter for this CDR is external, and for optimum results, a 30nF capacitor should be connected between pins 26 and 27. See the Typical Interface Circuit (*Figure 11*).

REMOTE SENSE

The remote sense feature can be used when a DS32EL0421 or DS32ELX0421 serializer is directly connected to a DS32EL0124 or DS32ELX0124 deserializer. Active components in the signal path between the serializer and the deserializer may interfere with the back channel signaling of the devices.

When remote sense is enabled, the deserializer will cycle through five states to successfully establish a link and align the data. The state diagram for the deserializer is shown in *Figure 7*. The deserialzer will remain in the low power IDLE state until it receives an input signal. Once the CDR of the deserializer has locked to the input clock, the device will enter the LINK DETECT state. While in this state, the serializer will monitor the line to see if the deserializer is present. If a deserializer is detected the serializer will enter the LINK ACQUISITION state. The serializer will transmit the entire training pattern and then enter the NORMAL state. If the deserializer is unable to successfully lock or maintain lock, it will break the link sending the serializer back to the IDLE or LINK DETECT states.

DC-BALANCE DECODER

The DS32EL0124 and DS32ELX0124 have a built-in DC-balance decoder to support AC-coupled applications. When enabled, the output signal RxOUT4+/-, is treated as a data valid bit. If RxOUT+/- is low, then the data output from RxOUT0-RxOUT3 has been successfully decoded using the 8b/10b coding scheme. If RxOUT4+/- is high and the outputs RxOUT0 -RxOUT3 are high then an invalid 8b/10b code was received, signifying a bit error. If RxOUT4+/- is high and the outputs RxOUT0 -RxOUT3 are low then an idle character has been received. The default idle character is a K28.5 code. In order to properly receive other Kcodes, they must first be programmed into the deserializer via the SMBus.

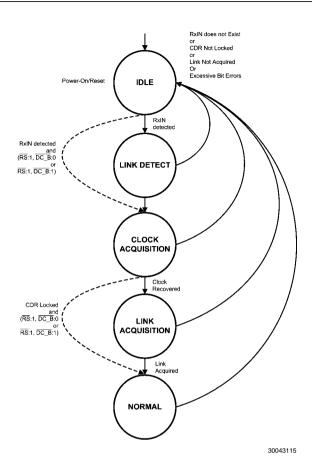


FIGURE 7. Deserializer State Diagram

DESCRAMBLER

If the descrambler is enabled, the raw or DC balanced serialized data is descrambled after the CDR to properly decode incoming data. Using the scrambler/descrambler helps to lower EMI emissions by spreading the spectrum of the data. Scrambling also creates transitions for a deserializer's CDR to properly lock onto.

The scrambler is enabled or disabled by default depending on how the $\overline{DC_B}$ and \overline{RS} pins are configured. To override the default scrambler setting two register writes must be performed. First, write to register XX'h and set bit X to unlock the descrambler register. Next write to register XX'h and change bit X to the desired value.

CML INPUT INTERFACING

The DS32ELX0124 has two inputs to support redundancy and failover applications. Either input can be selected by using the RX_MUX_SEL pin or internal control registers. Whichever input is selected will be routed to the CDR of the deserializer. Only one input may be selected at a time.

The input stage is self-biased and does not need any external bias circuitry. The DS32EL0124 and DS32ELX0124 include integrated input termination resistors. These deserializers also support a wide common mode input from 50mV to Vcc -50mV and can be DC-coupled where there is no significant Ground potential difference between the interfacing systems. The serial inputs also provides input equalization control in order to compensate for loss from the media. The level of equalization is controlled by the SMBus interface. For the

DS32ELX0124, each input can have its own independent equalizer settings.

It is recommended to use RxIN0+/- as the primary input for system that utilze the retimed loop through driver of the DS32ELX0124. When interfacing to RxIN1+/- and transmitting with the loop through driver on TxOUT+/-, it is important to follow good layout practices as described in the layout guidelines section and in the LVDS Owner's Manual. Poor layout techniques can result in excessive cross talk coupled into RxIN1.

CML OUTPUT INTERFACING (DS32ELX0124 ONLY)

The retimed loop through serial outputs of the DS32ELX0124 provide low-skew differential signals. Internal resistors connected from TxOUT+ and TxOUT- to VDD25 terminate the outputs. The output level can be programmed by adjusting the pull-down resistor to the VOD_CTRL pin. The output terminations can also be programmed to be either 50 or 75 ohms.

The output buffer consists of a current mode logic(CML) driver with user configurable de-emphasis control, which can be used to optimize performance over a wide range of transmission line lengths and attenuation distortions resulting from low cost CAT(-5, -6, -7) cable or FR4 backplane. Output de-emphasis is user programmable through SMBus interface. Users can control the strength of the de-emphasis to optimize for a specific system environment. Please see the Register Map for details.

DEVICE CONFIGURATION

There are four ways to configure the DS32EL0124 and DS32ELX0124 devices, these combinations are shown in *Table 1*. Depending on which features are enabled, the deserializers operate in very different ways. The Remote Sense and DC-Balance pins are active low configuration pins. The scrambler can be disabled through register programming.

When Remote Sense is enabled, with $\overline{\text{RS}}$ pin tied low, the deserializer must be connected directly to a DS32EL0421/DS32ELX0421 serializer without any active components between them. The Remote Sense module features both an upstream and downstream communication method for the serializer to detect a deserializer and vice versa. This feature is used to pass link status information between the 2 devices. If DC-Balance is enabled, the maximum number of parallel LVDS lanes is four. The fifth lane becomes a Data Valid signal (TXIN4±). Every time a DS32EL0421/DS32ELX0421 serializer establishes a link to a DS32EL0124/DS32ELX0124 deserializer with DC-Balance enabled, the Data Valid input to the serializer must be held high for 20 LVDS clock periods. If

the Data Valid input to the serializer is logic high, then SYNC characters are transmitted. If the deserializer receives a SYNC character, then the LVDS data outputs will all be logic low and the Data Valid outputs will be logic high. If the deserializer detects a DC-Balance code error, the output data pins will be set to logic high with the Data Valid output also set to logic high.

In the case where DC-Balance is enabled and Remote Sense is disabled, with \overline{RS} set to high and $\overline{DC_B}$ set to low, an external device must toggle the Data Valid input to the serializer periodically to ensure constant lock. With these pin settings the devices can interface with other active component in the high speed signal path, such as fiber modules.

When both Remote Sense and DC-Balance are disabled, RS and DC_B pins set to high, the data is not aligned. In this configuration, data formatting is handled by an FPGA or external source. This pin setting also allows for the devices to interface with other active components in the high speed signal path.

TABLE 1. Device Configuration Table

Remote Sense Pin (RS)	DC-Balance Pin(DC_B)	Configuration
0	0	Remote Sense enabled
		DC-Balance enabled
		Data Alignment
		De-Scrambler and NRZI decoder disabled by default
0	1	Remote Sense enabled
		DC-Balance disabled
		Data Alignment
		De-Scrambler and NRZI decoder enabled by default
1	0	Remote Sense disabled
		DC-Balance enabled
		Data Alignment
		De-Scrambler and NRZI decoder enabled by default
1	1	Remote Sense disabled
		DC-Balance disabled
		No Data Alignment
		De-Scrambler and NRZI decoder disabled by default

SMBus INTERFACE

The System Management Bus interface is compatible to SM-Bus 2.0 physical layer specification. The use of the Chip Select signal is required. Holding the SMB_CS pin HIGH enables the SMBus port, allowing access to the configuration registers. Holding the SMB_CS pin LOW disables the device's SMBus, allowing communication from the host to other slave devices on the bus. In the STANDBY state, the System Management Bus remains active. When communication to other devices on the SMBus is active, the SMB_CS signal for the deserializer must be driven LOW.

The address byte for all DS32EL0124 and DS32ELX0124 devices is B0'h. Based on the SMBus 2.0 specification, these devices have a 7-bit slave address of 1011000'b. The LSB is set to 0'b (for a WRITE), thus the 8-bit value is 1011 0000 'b or AE'h.

The SCK and SDA pins are 3.3V LVCMOS signaling and include high-Z internal pull up resistors. External low impedance pull up resistors maybe required depending upon SMBus loading and speed. Note, these pins are not 5V tolerant.

Transfer of Data via the SMBus

During normal operation the data on SDA must be stable during the time when SCK is HIGH.

There are three unique states for the SMBus:

START A HIGH to LOW transition on SDA while SCK is HIGH indicates a message START condition.

A LOW to HIGH transition on SDA while SCK is STOP HIGH indicates a message STOP condition.

If SCK and SDA are both HIGH for a time exceeding **IDLE** t_{BLIE} from the last detected STOP condition or if they are HIGH for a total exceeding the maximum specification for t_{HIGH} then the bus will transfer to the IDLE state.

SMBus Transactions

The devices support WRITE and READ transactions. See Register Description Table for register address, type (Read/ Write, Read Only), default value and function information.

Writing to a Register

The devices support WRITE and READ transactions. See Register Description Table for register address, type (Read/ Write, Read Only), default value and function information.

- The Host (Master) selects the device by driving its SMBus Chip Select (SMB_CS) signal HIGH.
- The Host drives a START condition, the 7-bit SMBus address, and a "0" indicating a WRITE.
- The Device (Slave) drives the ACK bit ("0").
- 4. The Host drives the 8-bit Register Address.
- The Device drives an ACK bit ("0"). 5.
- The Host drive the 8-bit data byte.
- 7. The Device drives an ACK bit ("0").
- The Host drives a STOP condition.

The Host de-selects the device by driving its SMBus CS signal Low.

The WRITE transaction is completed, the bus goes IDLE and communication with other SMBus devices may now occur.

Reading a Register

To read a register, the following protocol is used (see SMBus 2.0 specification).

- The Host (Master) selects the device by driving its SMBus Chip Select (SMB_CS) signal HIGH.
- The Host drives a START condition, the 7-bit SMBus address, and a "0" indicating a WRITE.
- The Device (Slave) drives the ACK bit ("0").
- The Host drives the 8-bit Register Address.
- The Device drives an ACK bit ("0").
- The Host drives a START condition. 6
- The Host drives the 7-bit SMBus Address, and a "1" indicating a READ.
- The Device drives an ACK bit "0".
- The Device drives the 8-bit data value (register contents).
- 10. The Host drives a NACK bit "1" indicating end of the READ transfer.
- 11. The Host drives a STOP condition.
- 12. The Host de-selects the device by driving its SMBus CS signal Low.

The READ transaction is completed, the bus goes IDLE and communication with other SMBus devices may now occur.

SMBus Configurations

Many different configurations of the SMBus are possible and depend upon the specific requirements of the applications. Several possible applications are described.

Configuration 1

The deserializer SMB_CS may be tied High (always enabled) since it is the only device on the SMBus. See Figure 8.

Configuration2

Since the multiple SER devices have the same address, the use of the individual SMB_CS signals is required. To communicate with a specific device, its SMB_CS is driven High to select the device. After the transaction is complete, its SMB CS is driven Low to disable its SMB interface. Other devices on the bus may now be selected with their respective chip select signals and communicated with. See Figure 9.

Configuration 3

The addressing field is limited to 7-bits by the SMBus protocol. Thus it is possible that multiple devices may share the same 7-bit address. An optional feature in the SMBus 2.0 specification supports an Address Resolution Protocol (ARP). This optional feature is not supported by the DS32EL0124/ DS32ELX0124 devices. Solutions for this include: the use of the independent SMB_CS signals, independent SMBus segments, or other means.

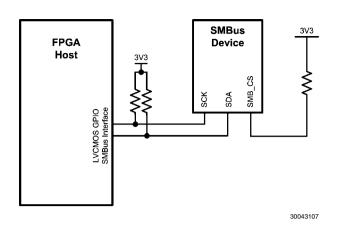


FIGURE 8. SMBus Configuration 1

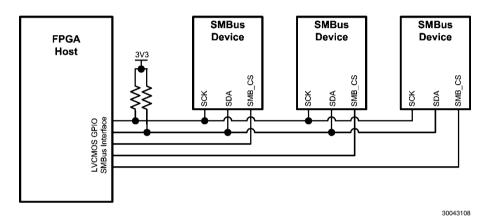


FIGURE 9. SMBus Configuration 2

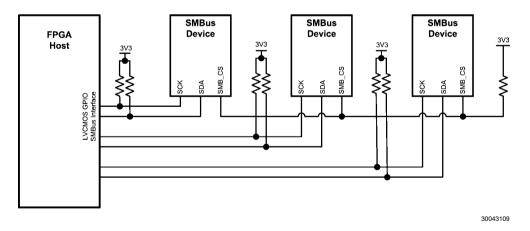


FIGURE 10. SMBus Configuration 3

Applications Information

GPIO PINS

The GPIO pins can be useful tools when debugging or evaluating the system. For specific GPIO configurations and functions refer to registers 2, 3, 4, 5 and 6 in the device register map.

GPIO pins are commonly used when there are multiple deserializers on the same SMBus. In order to program individual settings into each serializer, they will each need to have a unique SMBus address. To reprogram multiple deserializers on a single SMBus, configure the first deserializer such that the SMBus lines are connected to the FPGA or host controller. The CS pin of the second serializer should be tied to GPIO0 of the first deserializer, with the CS pin of the next deseriazlier tied to GPIO0 of its preceding deserializer. By holding all of the GPIO0 pins low, the first deserializer's address may now be reprogrammed by writing to register 0. The first deserializer's GPIO pin can now be asserted and the second deserializer's address may now be reprogrammed.

HIGH SPEED COMMUNICATION MEDIA

Using the deserializer's integrated equalizer blocks in combination with the DS32EL0421 or DS32ELX0421's integrated de-emphasis block allows data to be transmitted across a variety of media at high speeds. Factors that can limit device performance include excessive input clock jitter, noisy power rails, EMI from nearby noisy components and poor layout techniques. Although many cables contain wires of similar gauge and shielding, performance can vary greatly depending on the quality of the connector.

The DS32ELX0124 also has a programmable de-emphasis block on its retimed loop through output TxOUT+/-. The deemphasis setting for the loop through driver is programmed through the SMBus.

REDUNDANCY APPLICATIONS

The DS32ELX0124 has two high speed CML serial inputs. SMBus register control allows the host device to monitor for errors or link loss on the active input channel. This enables the host device, usually an FPGA, to switch to teh secondary input if problems occur with the primary input.

LINK AGGREGATION

Multiple DS32EL0421/DS32ELX0421 serializers and D32EL0124/DS32ELX0124 deserializers can be aggregated

together if an application requires a data throughput of more than 3.125 Gbps. By utilizing the data valid signal of each device, the system can be properly deskewed to allow for a single cable, such as CAT-6, DVI-D, or HDMI, to carry data payloads beyond 3.125 Gbps. The ELXEVK01 evaluation kit includes sample IP for a link aggregation system to operate at an application throughput of 6.25 Gbps.

Link aggregation configurations can also be implemented in applications which require longer cable lengths. In these type of applications the data rate of each serializer and deserializer chipset can be reduced, such that the applications' net data throughput is still the same. Since each high speed channel is now operating at a fraction of the original data rate, the loss over the cable is reduced, allowing for greater lengths of cable to be used in the system.

REACH EXTENSION

The DS32ELX0124 deserializer contains a retimed loop through CML serial output. The loop through driver also has programmable de-emphasis making this device capable of reach extension applications.

DAISY CHAINING

The loop through driver of the DS32ELX0124 deserializer can be used to string together deserializers in a daisy chain configuration. This allows a single data source such as a DS32EL0421 serializer to communicate to multiple receiving systems.

LAYOUT GUIDELINES

It is important to follow good layout practices for high speed devices. The length of LVDS input traces should not exceed 40 inches. In noisy environments the LVDS traces may need to be shorter to prevent data corruption due to EMI. Noisy components should not be placed next to the LVDS or CML traces. The LVDS and CML traces must have a controlled differential impedance of 100Ω . Do not place termination resistors at the CML inputs or output, the DS32EL0124 and DS32ELX0124 have internal termination resistors. It is recommended to avoid using vias. Each pair of vias creates an impedance mismatch in the transmission line and result in reflections, which can greatly lower the maximum distance of the high speed data link. If vias are required, they should be placed symmetrically on each side of the differential pair. For more tips and detailed suggestions regarding high speed board layout principles, please consult the LVDS Owner's Manual.

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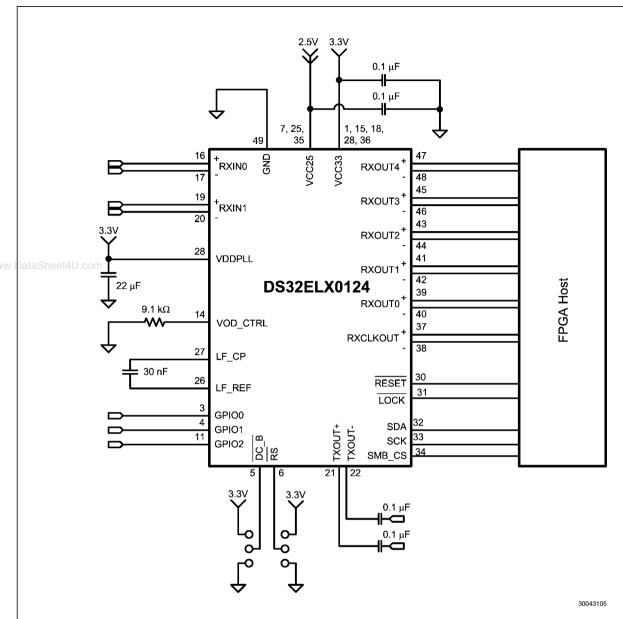


FIGURE 11. Typical Interface Circuit

Register Map

The register information for the deserializer is shown in the table below. Some registers have been omitted or marked as

reserved; these are for internal testing and should not be written to. Some register bits require an override bit to be set before they can be written to.

Addr (Hex)	Name	Bits	Field	R/W	Default	Description
00	Device ID	7:1	SMBus Address	R/W	58'h	Some systems will use all 8 bits as the device ID. This will shift the value from 58'h to B0'h
		0	Reserved		0	
01	Reset	7:1	Reserved			
		0	Software Reset	R/W	0	Reset the device. Does not affect device ID.
02 com	GPIO0 Config	7:4	GPIO0 Mode	R/W	0	0000: GP Out 0001: Signal Detect RxIN0 0010: BIST Status All Others: Reserved
		3:2	GPIO0 R Enable	R/W	01'b	00: Pullup/Pulldown disabled 01: Pulldown Enabled 10: Pullup Enabled 11: Reserved
		1	Input Enable	R/W	0	0: Input buffer disabled 1: Input buffer enabled
		0	Output Enable	R/W	1'b	0: Output Tri-State™ 1: Output enabled
03	GPIO1 Config	7:4	GPIO1 Mode	R/W	0	0000: Power On Reset 0001: GP Out 0010: Signal Detect RxIN1 0011:CDR Lock All Others: Reserved
		3:2	GPIO1 R Enable	R/W	01'b	00: Pullup/Pulldown disabled 01: Pulldown Enabled 10: Pullup Enabled 11: Reserved
		1	Input Enable	R/W	0	0: Input buffer disabled 1: Input buffer enabled
		0	Output Enable	R/W	1	0: Output Tri-State™ 1: Output enabled
04	GPIO2 Config	7:4	GPIO2 Mode	R/W	0	0000: GP Out 0001: Always on Clock Out 0010: LVDS Tx CLK 0011: CDR CLK All Others: Reserved
		3:2	GPIO2 R Enable	R/W	01'b	00: Pullup/Pulldown disabled 01: Pulldown Enabled 10: Pullup Enabled 11: Reserved
		1	Input Enable	R/W	0	0: Input buffer disabled 1: Input buffer enabled
		0	Output Enable	R/W	1'b	0: Output Tri-State™ 1: Output enabled

Addr (Hex)	Name	Bits	Field	R/W	Default	Description
05	GP In	7:3	Reserved			
		2	GP In 2	R	0	Input value on GPIO2
		1	GP In 1	R	0	Input value on GPIO1
		0	GP In 0	R	0	Input value on GPIO0
06	GP Out	7:3	Reserved			
		2	GP Out 2	R/W	0	Output value on GPIO2
		1	GP Out 1	R/W	0	Output value on GPIO1
		0	GP Out 0	R/W	0	Output value on GPIO0
07 — 1F Re	served	'			Į.	
20	7	Reserved		0		
	6	Disable Data Valid	R/W	0		
	5:3	Reserved		0		
Sheet4U.con	2	Reverse Data Order	R/W	0		0: Normal 1: Reverse output data order
	1	Reset Channel	R/W	0		Reset input high speed channel
	0	Digital Powerdown	R/W	0		Power down parallel, seriato-parallell, and always on clock
21	Device Config	7	Reserved		0	
		6	NRZ Decode Enable	R/W	0	Enable NRZ decoding of incoming data; requires an override bit
		5	Descramble Enable	R/W	0	Enabled the descrambler, requires an override bit
		4	Rx Mux	R/W	0	RX_MUX_SEL control register. requires an override bit
		3	Decode Bypass	R/W	0	Bypass DC Balance decoder. requires an override bit
		2	Training Sequence Enable	R/W	0	Enable training sequence. requires an override bit
		1:0	Device Configuartion	R/W	0	MSB: Remote Sense enable, active low LSB: DC balance encoder enable, active low requires an override bit
22	Device Config	7	Reserved			
	Override	6	NRZ Override	R/W	0	Unlock bit 6 of register 21'h
		5	Descramble Override	R/W		Unlock bit 5 of register 21'h
		4	Rx Mux Override	R/W		Unlock bit 4 of register 21'h
		3	Reserved			
		2	Decode Bypass Override	R/W		Unlock bit 3 of register 21'h
		1	Traning Override	R/W		Unlock bit 2 of register 21'h
		0	Device Config Override	R/W		Unlock bits 1 and 0 of register 21'h
23 — 26 Re	served				!	

DS32EL0124/DS32ELX0124

Addr (Hex)

27

2C

Reserved

Name

LVDS Per Channel

Bits

Field

LVDS V_{OD} High

R/W

R/W 0

Default

Description

0: LVDS V_{OD} normal

Enable operation. Setting used in **Electrical Characteristics** Table 1: Increases V_{OD}. Allows for longer traces to be driven, but consume more power R/W 0 LVDS Control 1: Allow SMBus to control LVDS per channel enable R/W 0 **Enables RxCLKOUT** 5 **RxCLKOUT Enable** output driver R/W 0 RxOUT4 Enable Enables RxOUT4 output driver 3 RxOUT3 Enable R/W 0 Enables RxOUT3 output www.DataSheet4U.dom driver R/W 0 2 Enables RxOUT2 output RxOUT2 Enable driver R/W 0 1 RxOUT1 Enable Enables RxOUT1 output driver 0 R/W 0 RxOUT0 Enable Enables RxOUT0 output driver 28 LVDS Config Reserved 0 R/W 0 Resets LVDS block 6 LVDS Reset 5 LVDS Clock Rate R/W 1 0:RxCLKOUT is DDR/2 1: RxCLKOUT is DDR R/W 0 4 LVDS Clock Invert Inverts the polarity of the RxCLKOUT signal 000: No clock delay 3:2 LVDS Clock Delay R/W 10'b 111: Max clock delay, 1000 ps See t_{LVDL} in LVDS **Switching Characteristics** for more details 1:0 Reserved 0 - 2A Reserved 29 2B **Event Config** 7:4 Reserved 3 **Event Count Select** R/W 0 0: Select CDR Event Counter for reading. Events include loss of signal detect or loss of CDR lock. 1: Select Data Event Counter for reading Reset CDR Error Count R/W 0 Reset s CDR event count R/W lo Reset Link Error Count Reset data event count 0 R/W 0 **Enable Count** Enable event coutners

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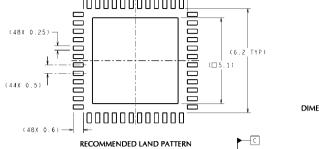
Addr (Hex)	Name	Bits	Field	R/W	Default	Description
2D	Error Monitor	7:5	Reserved			
		4	Accumulate Error Enable	R/W		Enable counting accumulation of errors
		3	8b/10b Error disable	R/W		1: Disables 8b/10b decode errors from being counted or flagged on LOCK pin
		2	Clear Event Counter	R/W		1: clears errors in both the current and previous state of teh errors count
		1	Select Error Count	R/W		O: Number of errors in current run I: Number of errors within the selected timing window
Sheet4U.con	1	0	Normal Error Disable	R/W		1: Disable exiting NORMAL state when the number of errors exceeds the error threshold
2E	Error Threshold LSBs	7:0	Error Threshold	R/W	10'h	Error threshold above which part stops transmittion of data — LSB
2F	Error Threshold MSBs	7:0	Error Threshold	R/W	0	Error threshold above which part stops transmittion of data — MSB
30 — 3A Re	served					
3B	Data Rate	7	Reserved			
		6:4	Frequency Range	R	111'b	001: Reserved 010: 1 — 1.3 Gbps 011: 1.2 — 1.8 Gbps 100: 1.5 — 2.1 Gbps 101: 1.9 — 2.7 Gbps 110: 2.4 — 3.2 Gbps 111: No Lock
		3:2	BIST Status	R	0	00: BIST passed 01: BIST failed to capture PREAMBLE 10: BIST pattern mode failed 11: BIST data sequence failed
		1	BIST Done	R		BIST pattern done. Set when not using repeat.
		0	BIST Allign Done	R	0	Alignment of incoming data done
3C	Reserved					
3D	Event Status	7:0	Event Count	R	0	Count of errors that caused a loss of link
3E	Error Status LSBs	7:0	Data Error Count	R	0	Number of errors in data — LSB
3F	Errors Status MSBs	7:0	Data Error Count	R	0	Number of errors in data — MSB
40 — 49 Res	served					

DS32EL0124/DS32ELX0124

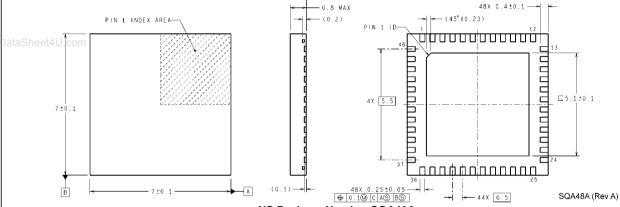
		ot.

Addr (Hex)	Name	Bits	Field	R/W	Default	Description
49 Loop Throuς Config	Loop Through Driver Config	7:5	Reserved		0	
		4	Termination Select	R/W	1	0: 75Ω
						1: 50 Ω
		3:1	Output Amplitude Adjust	R/W	011'b	000: Level 7
						001: Level 8 (Highest
						output)
						010: Level 5
						011: Level 6 (Normal
						output)
						100: Level 4
						101: Level 3
						110: Level 2
om						111: Level 1 (Lowest output)
		0	Reserved		0	output)
	EQ Attenuator	7:4	Reserved		0	
	EQ Attenuator	3	Attenuator 0 Override	R/W	0	Overwide a ottonivation
		3	Allenuator o Overnde	H/VV	0	Overrides attenuation control in EQ 0
		2	Attenuator 1 Override	R/W	0	Overrides attenuation
						control in EQ 1
		1	Attenuator 0 Enable	R/W	0	1: enables attenuatorfor for
						EQ 0. Requires bit 3 to be
						set
		0	Attenuator 1 Enable	R/W	0	Enables attenuato for EQ 1.
						Requires bit 2 to be set.r
61	EQ Boost Control	7:5	EQ 0 Boost Control		0	Sets EQ level for RxIN0.
						Requires override bit
		4:2	EQ 1 Boost Control		0	Sets EQ level for RxIN1.
						Requires override bit
		1:0	Reserved			
62	Reserved					
63	EQ Override Control	7				
		6				
		5	EQ 0 Enable	R/W	1	Enables EQ for RxIN0
		4	EQ 1 Enable	R/W	0	Enables EQ for RxIN1
		3:0	Reserved			

Physical Dimensions inches (millimeters) unless otherwise noted



DIMENSIONS ARE IN MILLIMETERS



NS Package Number SQA48A (See AN-1187 for PCB Design and Assembly Recommendations)

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